



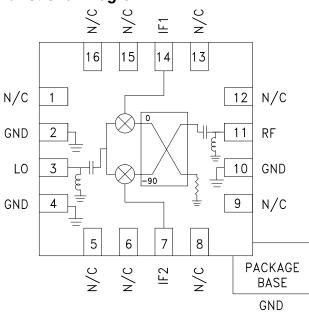
GaAs MMIC I/Q MIXER 24 - 28 GHz

Typical Applications

The HMC1063LP3E is ideal for:

- Point-to-Point and Point-to-Multi-Point Radio
- Military Radar, EW & ELINT
- Satellite Communications
- Sensors

Functional Diagram



Features

Low LO Power: 10 dBm

Wide IF Bandwidth: DC - 3 GHz

Image Rejection: 21 dBc LO / RF Isolation: 40 dB High Input IP3: 17 dBm

16 Lead 3x3 mm SMT Package: 9 mm²

General Description

The HMC1063LP3E is a compact I/Q MMIC mixer in a leadless "Pb free" SMT package, which can be used as either an Image Reject Mixer or a Single Sideband Upconverter. The mixer utilizes two standard Hittite double balanced mixer cells and a 90 degree hybrid fabricated in a GaAs Schottky diode process. A low frequency quadrature hybrid was used to produce a 1000 MHz LSB IF output. This product is a much smaller alternative to hybrid style Image Reject Mixers and Single Sideband Upconverter assemblies. The HMC1063LP3E eliminates the need for wire bonding and allows the use of surface mount manufacturing techniques.

Electrical Specifications [1][2], $T_A = +25$ °C, IF = 1000 MHz, LSB, LO = +10 dBm

Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range, RF		24 - 27	,	27- 28			GHz
Frequency Range, LO		21 - 30		24 - 31			GHz
Frequency Range, IF		DC - 3			DC - 3		GHz
Conversion Gain	-11.5	-9.5		-11.5	-9.5		dB
Image Rejection	15	21		13	21		dBc
LO to RF Isolation	30	42		28	36		dB
LO to IF Isolation		40			40		dB
IP3 (Input)		18			16		dBm
Amplitude Balance [2]		1			1		dB
Phase Balance [2]		-2			+2		Deg

^[1] Unless otherwise noted all measurements performed as downconverter.

^[2] Data taken without external 90° hybrid.

HMC1063* PRODUCT PAGE QUICK LINKS

Last Content Update: 02/23/2017

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View a parametric search of comparable parts.

EVALUATION KITS

· HMC1063LP3 Evaluation Board

DOCUMENTATION

Data Sheet

• HMC1063 Data Sheet

DESIGN RESOURCES 🖳

- HMC1063 Material Declaration
- PCN-PDN Information
- · Quality And Reliability
- Symbols and Footprints

DISCUSSIONS

View all HMC1063 EngineerZone Discussions.

SAMPLE AND BUY 🖵

Visit the product page to see pricing options.

TECHNICAL SUPPORT 🖳

Submit a technical question or find your regional support number.

DOCUMENT FEEDBACK 🖳

Submit feedback for this data sheet.

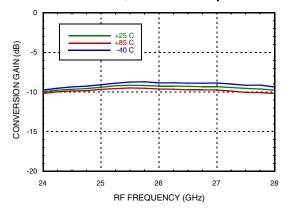




GaAs MMIC I/Q MIXER 24 - 28 GHz

Data Taken as SSB Downconverter with External IF 90° Hybrid, IF = 1000 MHz

Conversion Gain, LSB vs. Temperature



Conversion Gain, LSB vs. LO Drive

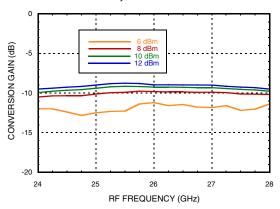


Image Rejection, LSB vs. Temperature

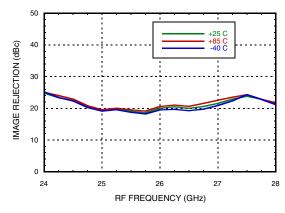
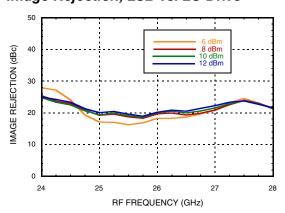
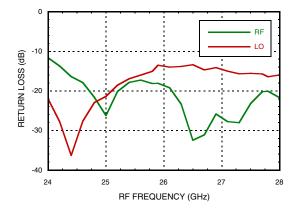


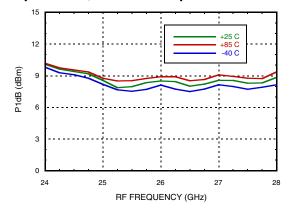
Image Rejection, LSB vs. LO Drive



Return Loss



Input P1dB, LSB vs. Temperature



[1] Data taken without external IF 90° hybrid

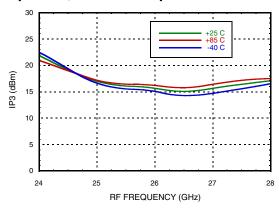




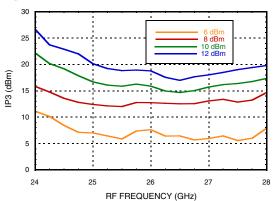
GaAs MMIC I/Q MIXER 24 - 28 GHz

Data Taken as SSB Downconverter with External IF 90° Hybrid, IF = 1000 MHz

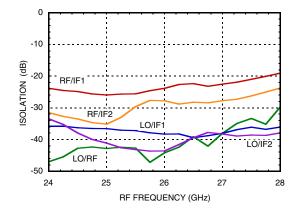
Input IP3, LSB vs. Temperature



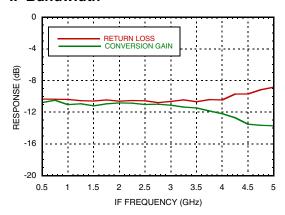
Input IP3, LSB vs. LO Drive



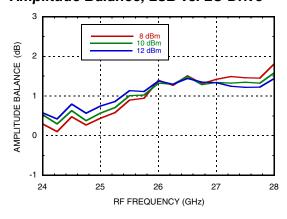
Isolations



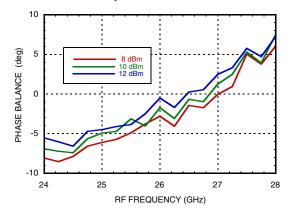
IF Bandwidth*



Amplitude Balance, LSB vs. LO Drive



Phase Balance, LSB vs. LO Drive



^{*} Conversion gain data taken with external IF hybrid.

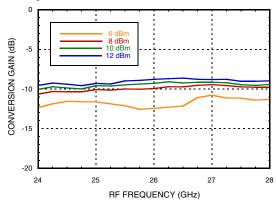




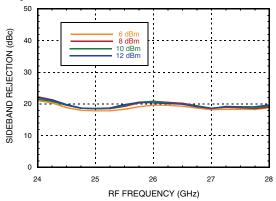
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Data Taken as SSB Downconverter with External IF 90° Hybrid, IF = 1000 MHz

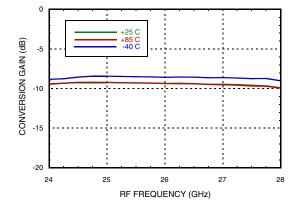
Upconverter Performance, Conversion Gain, LSB vs. LO Drive



Upconverter Performance, Sideband Rejection, LSB vs. LO Drive,



Conversion Gain, USB vs. Temperature



Conversion Gain, USB vs. LO Drive

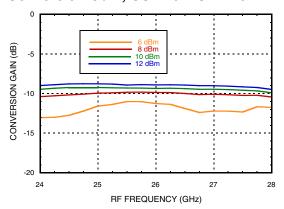


Image Rejection, USB vs. Temperature

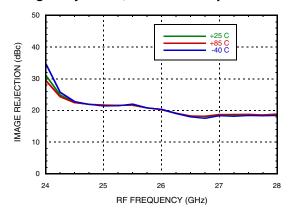
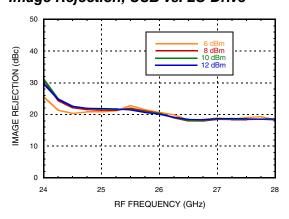


Image Rejection, USB vs. LO Drive



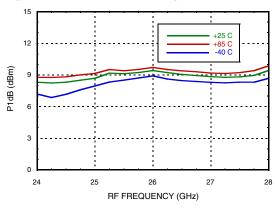




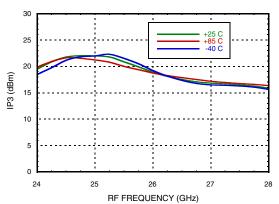
GaAs MMIC I/Q MIXER 24 - 28 GHz

Data Taken as SSB Downconverter with External IF 90° Hybrid, IF = 1000 MHz

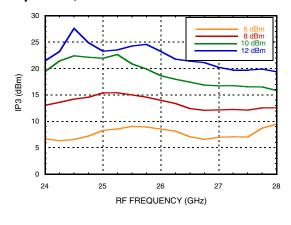
Input P1dB, USB vs. Temperature



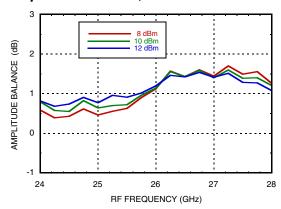
Input IP3, USB vs. Temperature



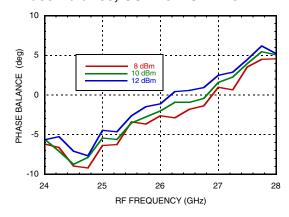
Input IP3, USB vs. LO Drive



Amplitude Balance, USB vs. LO Drive



Phase Balance, USB vs. LO Drive



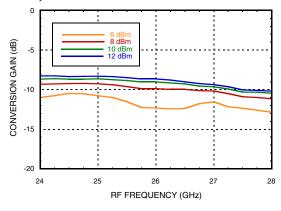




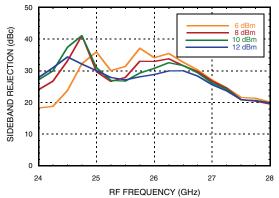
GaAs MMIC I/Q MIXER 24 - 28 GHz

Data Taken as SSB Upconverter with External IF 90° Hybrid, IF = 1000 MHz

Upconverter Performance, Conversion Gain, USB vs. LO Drive



Upconverter Performance, Sideband Rejection, USB vs. LO Drive,



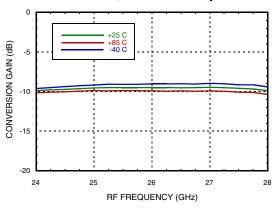




GaAs MMIC I/Q MIXER 24 - 28 GHz

Data Taken as SSB Downconverter with External IF 90° Hybrid, IF = 3000 MHz

Conversion Gain, LSB vs. Temperature



Conversion Gain, LSB vs. LO Drive

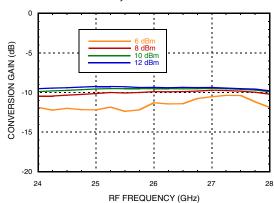


Image Rejection, LSB vs. Temperature

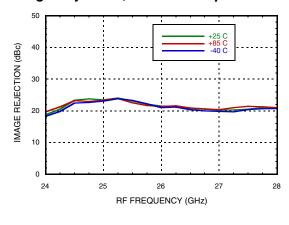
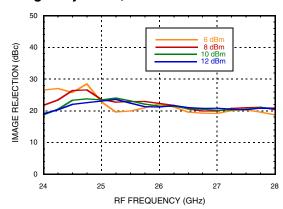
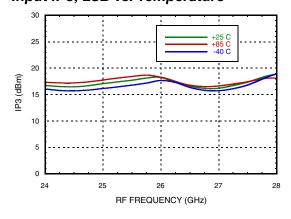


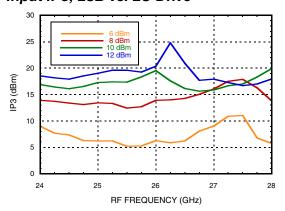
Image Rejection, LSB vs. LO Drive



Input IP3, LSB vs. Temperature



Input IP3, LSB vs. LO Drive

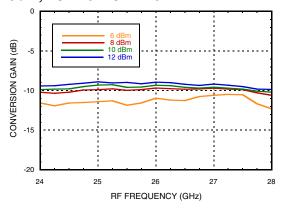




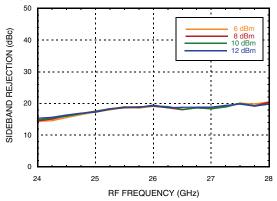
GaAs MMIC I/Q MIXER 24 - 28 GHz

Data Taken as SSB Downconverter with External IF 90° Hybrid, IF = 3000 MHz

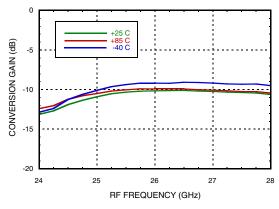
Upconverter Performance, Conversion Gain, LSB vs. LO Drive



Upconverter Performance, Sideband Rejection, LSB vs. LO Drive,



Conversion Gain, USB vs. Temperature



Conversion Gain, USB vs. LO Drive

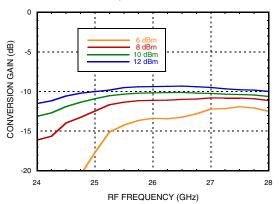


Image Rejection, USB vs. Temperature

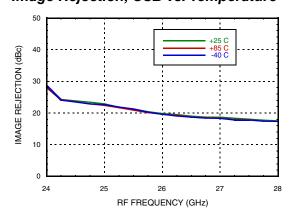
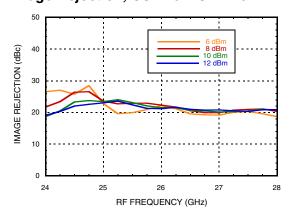


Image Rejection, USB vs. LO Drive



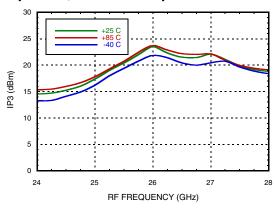




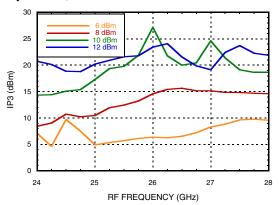
GaAs MMIC I/Q MIXER 24 - 28 GHz

Data Taken as SSB Downconverter with External IF 90° Hybrid, IF = 3000 MHz

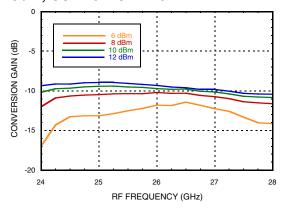
Input IP3, USB vs. Temperature



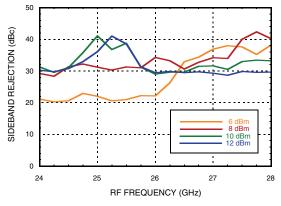
Input IP3, USB vs. LO Drive



Upconverter Performance, Conversion Gain, USB vs. LO Drive



Upconverter Performance, Sideband Rejection, USB vs. LO Drive,







GaAs MMIC I/Q MIXER 24 - 28 GHz

Harmonics of LO

105 (011)	nLO Spur at RF Port					
LO Freq. (GHz)	1	2	3			
23	36.6	43.3	х			
24	33.8	46.4	х			
25	32.1	49.4	х			
26	29.6	x	х			
27	31.8	х	х			
28	32.8	х	х			

LO = + 10 dBm Values in dBc below LO level measured at RF Port.

MxN Spurious Outputs

	nLO					
mRF	0	1	2	3	4	
0	XX	1	28	х	х	
1	8	0	34	60	х	
2	95	53	51	58	87	
3	х	97	97	97	97	
4	х	х	х	97	97	

RF = 22 GHz @ -10 dBm

LO = 23 GHz @ +10 dBm

Data taken without IF hybrid

All values in dBc below IF power level





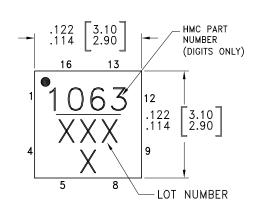
GaAs MMIC I/Q MIXER 24 - 28 GHz

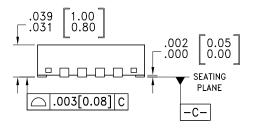
Absolute Maximum Ratings

IF Input (At LO = 10 dBm and RF = -10 dBm)	+11.5 dBm	
RF Input (At 10 dBm LO Power)	+13 dBm	
LO Input (At -10 dBm RF Power)	+14.5 dBm	
Channel Temperature	175 °C	
Continuous Pdiss (T = 85°C) (derate 6 mW/°C above 85°C)	550 mW	
Thermal Resistance (channel to ground paddle)	164 °C/W	
Storage Temperature	-65 to +150 °C	
Operating Temperature	-40 to +85 °C	
ESD Sensitivity (HBM)	Class 1A	



Outline Drawing





BOTTOM VIEW PIN 16 .008 [0.40] REF .007 [0.30] .008 [0.20] MIN .061 [1.56] .057 [1.44] .022 [0.56] .057 [1.95] .059 [1.50] .079 [1.95] .059 [1.50] .079 [1.95] .059 [1.50] .070 PADDLE SQUARE

NOTES:

- PACKAGE BODY MATERIAL: LOW STRESS INJECTION MOLDED PLASTIC SILICA AND SILCON IMPREGNATED.
- 2. LEAD AND GROUND PADDLE MATERIAL: COPPER ALLOY.
- 3. LEAD AND GROUND PADDLE PLATING: 100% MATTE TIN.
- 4. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- 5. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- 6. PAD BURR LENGTH SHALL BE 0.15mm MAX. PAD BURR HEIGHT SHALL BE 0.05mm MAX.
- 7. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- 8. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating [2]	Package Marking [1]
HMC1063LP3E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1	<u>H1063</u> XXXX

^{[1] 4-}Digit lot number XXXX

[2] Max peak reflow temperature of 260 $^{\circ}\text{C}$





GaAs MMIC I/Q MIXER 24 - 28 GHz

Pin Descriptions

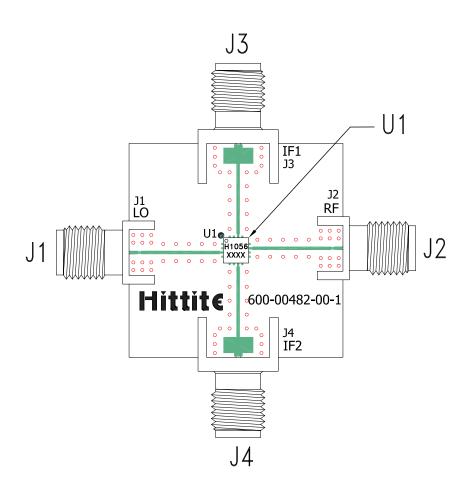
Pin Number	Function	Description	Interface Schematic
1, 5, 6, 8, 9, 12, 13, 15, 16	N/C	These pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally.	
2, 4, 10	GND	These pins and exposed ground paddle must be connected to RF/DC ground	○ GND =
3	LO	This pin is DC coupled and matched to 50 Ohns	0
7	IF2	Differential IF input pins. For applications not requiring operation to DC, an off chip DC blocking capacitor should be used. For operation to DC this pin must not source/sink	IF1,IF2
14	IF1	more than 3 mA of currrent or part non function and and possible part failure will result.	
11	RFOUT	This pin is DC coupled and matched to 50 Ohms.	RF O





GaAs MMIC I/Q MIXER 24 - 28 GHz

Evaluation PCB



List of Materials for Evaluation PCB EVAL01-HMC1063LP3 [1]

Item	Description		
J1, J2	PCB mount K Connector SRI		
J3, J4	PCB mount SMA Connector Johnson		
U1	HMC1063LP3E Downconverter		
PCB [2]	600-00482-00-1 Evaluation Board		

[1] Reference this number when ordering complete evaluation PCB $\,$

[2] Circuit Board Material: Arlon 25FR, FR4 or Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.



MIXERS - I/Q MIXERS, IRMS & RECEIVERS - SMT

ANALOGDEVICES

ROHS V

Notes:

GaAs MMIC I/Q MIXER 24 - 28 GHz